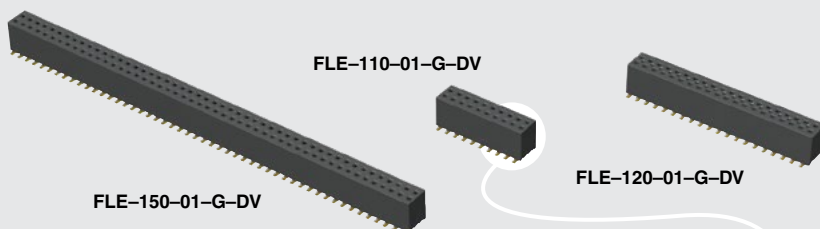


(1.27 mm) .050"



FLE SERIES

COST-EFFECTIVE RELIABLE SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?FLE

Insulator Material:

Black Liquid
Crystal Polymer

Contact Material:

Phosphor Bronze

Plating:

Au over 50 μ " (1.27 μ m) Ni

Current Rating:

2.9 A per pin

(2 pins powered)

Operating Temp Range:

-55 °C to +125 °C

Insertion Depth:

(1.83 mm) .072" to

(4.37 mm) .172" or

pass-through

Normal Force:

100 grams (0.98 N)

Max Cycles:

100+

RoHS Compliant:

Yes

Board Mates:

FTSH, FTS, FW

Cable Mates:

FFMD*, FMTF

*Note: Standard FFMD callout will not mate with FLE, SFMC. Must use gold plated callouts. (See drawing on web.)

Tiger Beam™
contact

Ideal for
pass-through
applications



HIGH-SPEED CHANNEL PERFORMANCE

Rating based on Samtec reference channel. For full SI performance data visit Samtec.com or contact SI@samtec.com

8
Gbps

Surface
mount

(1.27 mm) .050"
micro pitch

Available with optional
pick & place pads

PROCESSING

Lead-Free Solderable:

Yes

SMT Lead Coplanarity:

(0.10 mm) .004" max

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



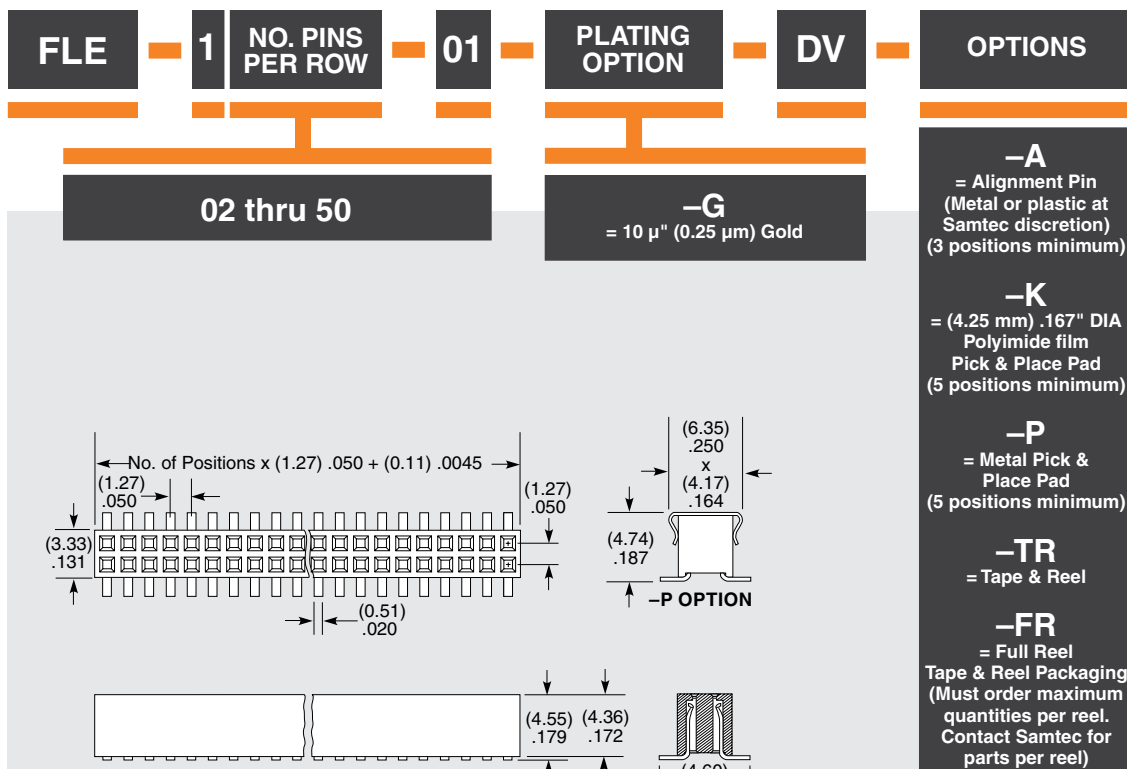
FILE NO. E111594

ALSO AVAILABLE (MOQ Required)

- Other platings

Note:

Some lengths, styles and options are non-standard, non-returnable.



Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM

All parts within this catalog are built to Samtec's specifications.

Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.